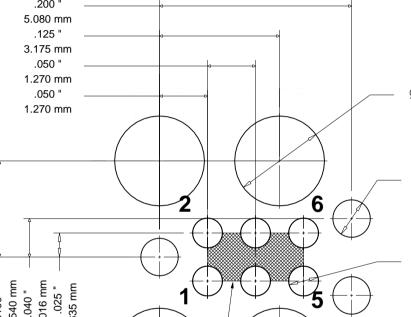
## **Notes:**

- 1. Allow clearance for finger squeeze access from the two sides shown.
- 2. No tracks or vias in the shaded "KEEP OUT" AREA.
- 3. No other track or signal within .02" of any contact pad.
- 4. Do not allow solder paste on the contact pads It is essential to eliminate any hole in the solder paste-mask (solder stencil) layer. If this is not possible make the contact pads thru-hole with a finished hole size of .008" or less.
- 5. Leg and alignment holes may be plated and used as vias but ensure minimum finshed hole size meets specified tolerances.
- 6. To prevent purchasing confusion, please specify DNL in your BOM.

## Allow finger access from this side 5.080 mm

ZONE

REV



Ø.0935 "± .0030 Ø2.375 mm± .076 **NON-PLATED** THRU HOLE LEG LATCH HOLES

12/2/10

Ø.039 "±.003 Ø.991 mm+ .076 NON-PLATED THRU HOLE ALIGNMENT PIN HOLES

Ø.787 mm± .076 Ø.031 "± .003 CONDUCTIVE CONTACT PADS NO SOLDER PASTE

PCB BOTTOM VIEW

.061 "

1.549 mm

Allow finger access from this side

"KEEP OUT" AREA

ALLOW A .061 X .046 SQUARE AREA OF CLEARANCE FOR **EACH FOOT** 

.046 "

1.168 mm

Α
SCALE

SIZE FSCM NO. Α

**FOOTPRINT FOR** TC2030-MCP-FP

REV Α

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FOOTPRINT FOR TC2030-MCP PLUG-OF-NAILS (TM) CABLE

TC2030-MCP-FP

SHEET 1 Of 3

Microchip ICD / ICSP signals

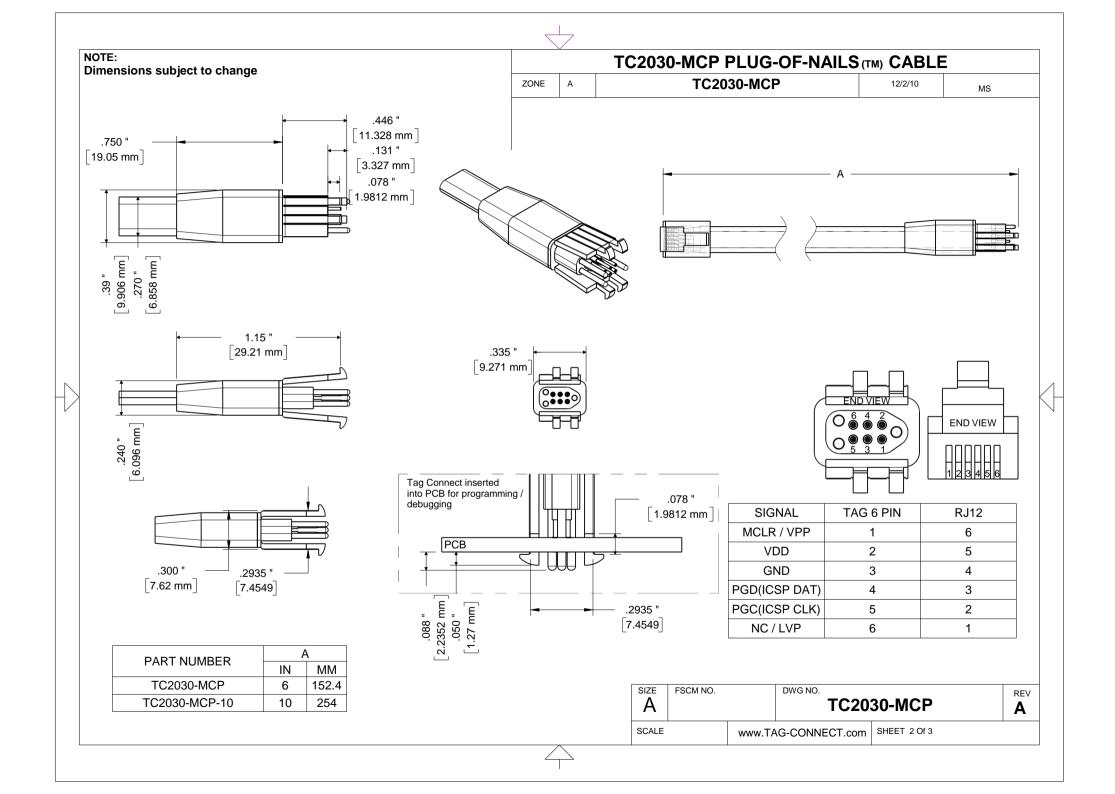
Pin 1: MCLR / Vpp

Pin 2: Vdd

Pin 3: GND

Pin 4: PGD (ICSPDAT) Pin 5: PGC (ICSPCLK)

Pin 6: Unused / LVP



## Layout Problems to Avoid

